Ordering number:ENN5491B

P-Channel Silicon MOSFET

2SJ466

Ultrahigh-Speed Switching Applications

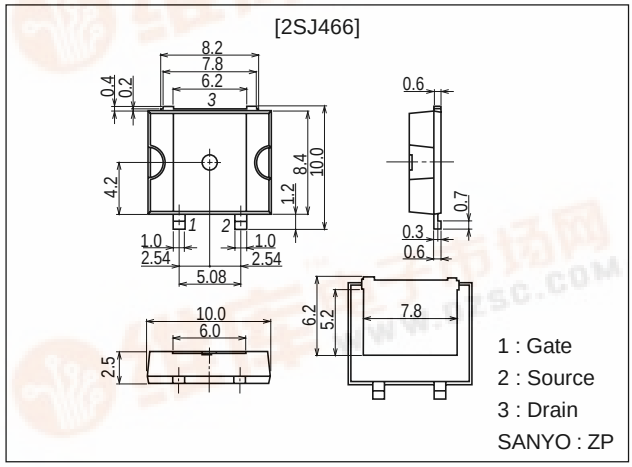
Features

- Low ON resistance.
- Ultrahigh-speed switching.
- 4V drive.
- Enables simplified fabrication, high-density mounting, and miniaturization in end products due to the surface mountable package.

Package Dimensions

unit:mm

2128



Specifications

Absolute Maximum Ratings at Ta = 25˚C

Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	V_{DSS}		–30	V
Gate-to-Source Voltage	V_{GSS}		±20	V
Drain Current (DC)	I_D		–35	A
Drain Current (Pulse)	I_{DP}	PW≤10μs, duty cycle≤1%	–140	A
Allowable Power Dissipation	P_D	Tc=25˚C	50	W
Channel Temperature	Tch		150	˚C
Storage Temperature	Tstg		–55 to +150	˚C

Electrical Characteristics at Ta = 25˚C

Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Drain-to-Source Breakdown Voltage	$V_{(BR)DSS}$	I_D=–1mA, V_{GS}=0	–30			V
Gate-to-Source Breakdown Voltage	$V_{(BR)GSS}$	I_G=±100μA, V_{DS}=0	±20			V
Zero-Gate Voltage Drain Current	I_{DSS}	V_{DS}=–30V, V_{GS}=0			–100	μA
Gate-to-Source Leakage Current	I_{GSS}	V_{GS}=±16V, V_{DS}=0			±10	μA
Cutoff Voltage	V_{GS}(off)	V_{DS}=–10V, I_D=–1mA	–1.0		–2.0	V
Forward Transfer Admittance	| yfs |	V_{DS}=–10V, I_D=–18A	16	27		S
Static Drain-to-Source ON-State Resistance	R_{DS}(on)	I_D=–18A, V_{GS}=–10V		20	30	mΩ
		I_D=–18A, V_{GS}=–4V		30	40	mΩ

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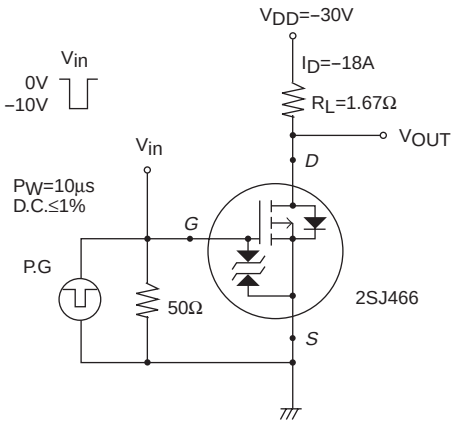
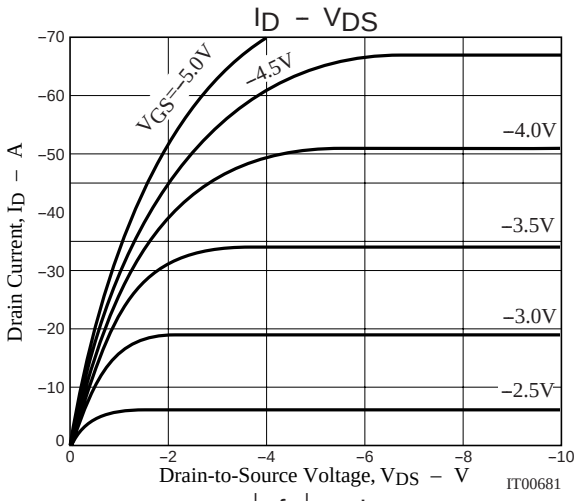
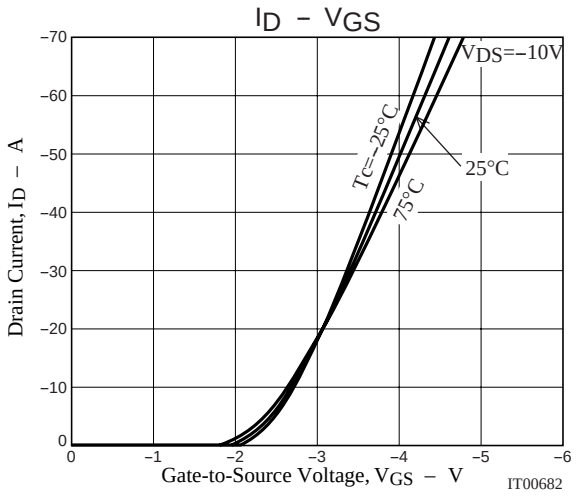
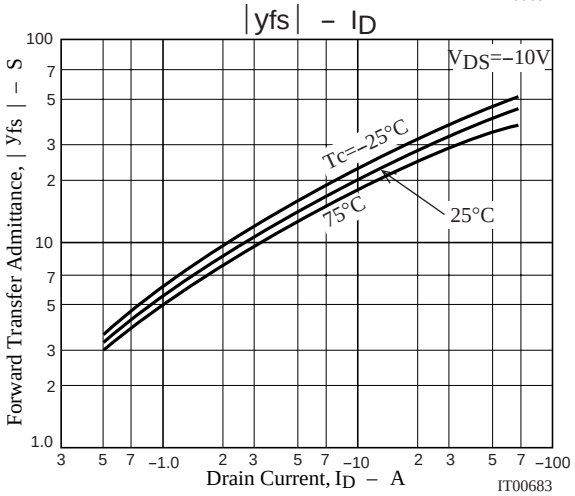
Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Input Capacitance	Ciss	V_{DS}=–10V, f=1MHz		4000		pF
Output Capacitance	Coss	V_{DS}=–10V, f=1MHz		2400		pF
Reverse Transfer Capacitance	Crss	V_{DS}=–10V, f=1MHz		880		pF
Turn-ON Delay Time	$t_{d(on)}$	See specified Test Circuit		30		ns
Rise Time	t_r	See specified Test Circuit		200		ns
Turn-OFF Delay Time	$t_{d(off)}$	See specified Test Circuit		500		ns
Fall Time	t_f	See specified Test Circuit		270		ns
Diode Forward Voltage	V_{SD}	I_S=–35A, V_{GS}=0		–1.0	–1.5	V

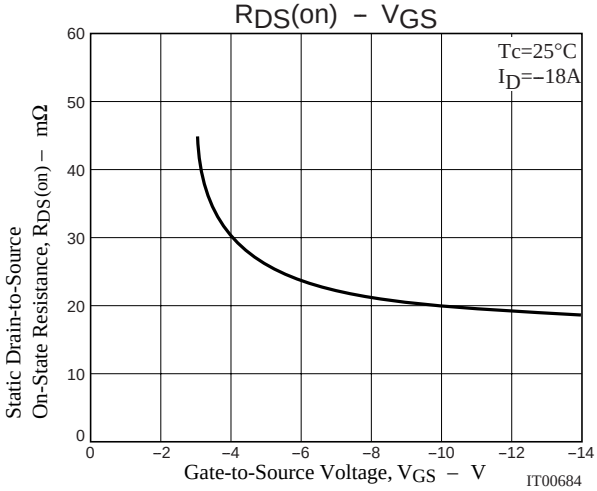
Switching Time Test Circuit

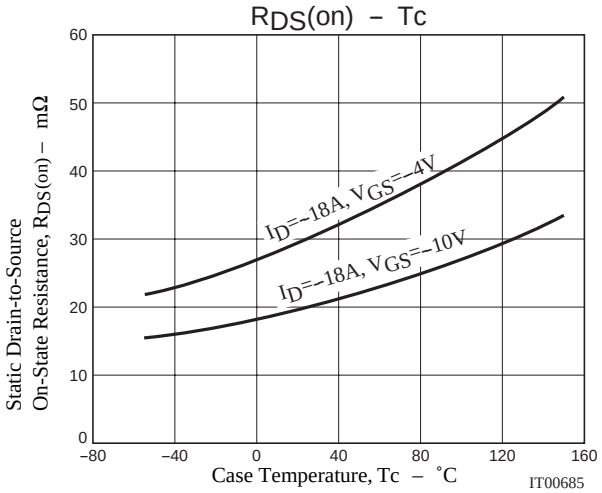


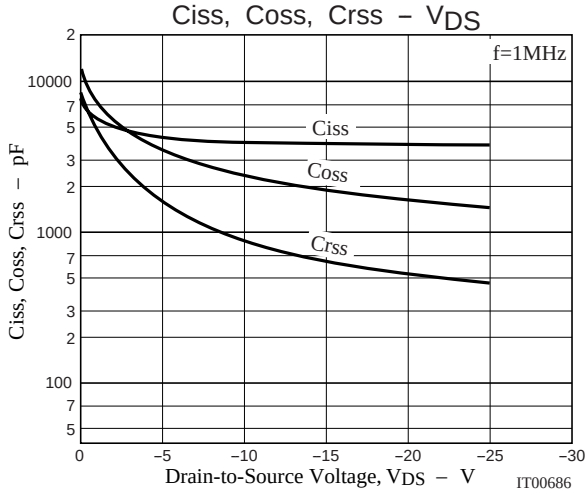


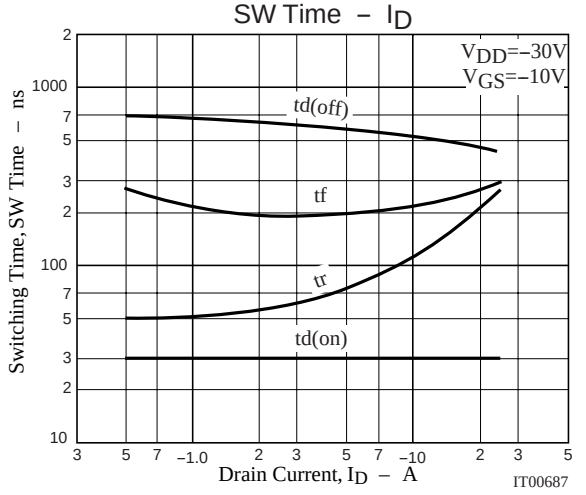


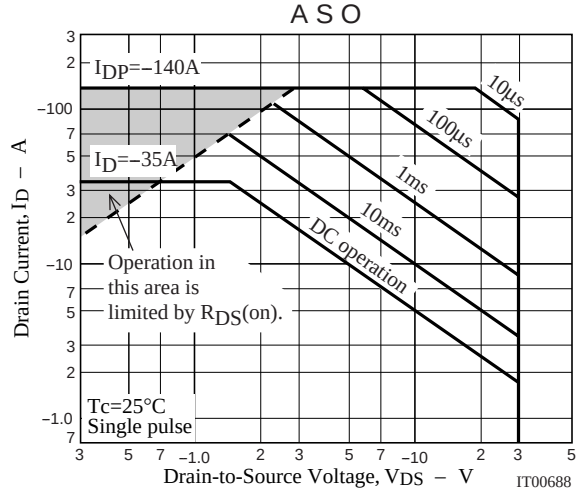


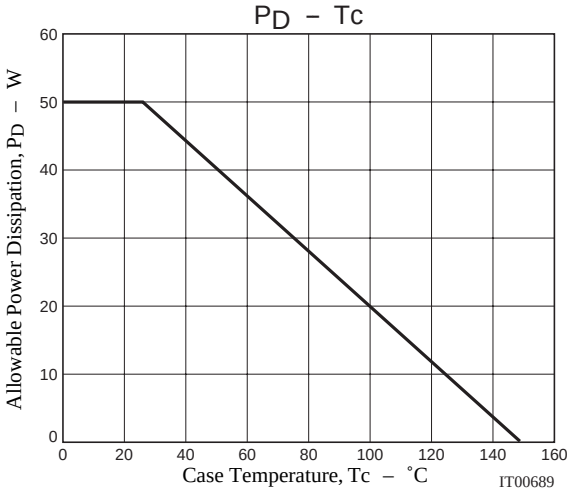



RDS(on) – Tc
Static Drain-to-Source On-State Resistance, RDS(on) – mΩ
ID=–18A, VGS=–4V
ID=–18A, VGS=–10V
Case Temperature, Tc – °C
IT00685


Ciss, Coss, Crss – VDS
f=1MHz
Ciss
Coss
Crss
Ciss, Coss, Crss – pF
Drain-to-Source Voltage, VDS – V
IT00686


SW Time – ID
VDD=–30V
VGS=–10V
td(off)
tf
tr
td(on)
Switching Time, SW Time – ns
Drain Current, ID – A
IT00687


A S O
IDP=–140A
ID=–35A
10µs
100µs
1ms
10ms
DC operation
Operation in this area is limited by RDS(on).
Tc=25°C
Single pulse
Drain Current, ID – A
Drain-to-Source Voltage, VDS – V
IT00688


PD – Tc
Allowable Power Dissipation, PD – W
Case Temperature, Tc – °C
IT00689